

nanoShear R2 PVA Brushes

Rippey nanoShear R2 brushes were developed to address ≤22nm BEoL post-CMP physical defect

challenges (e.g. circle scratching). Tailored specifically for softer metal films, nanoShear R2 brushes protect the interconnect metal while maintaining particle

removal efficiency. nanoShear R2 brushes reduce metal

open defects and improve EM/SM performance.

for critical BEoL post-CMP cleaning applications

BEoL • Copper • Cobalt • Ruthenium

Description





Wafer Circle scratch

Features

Rippey nanoShear R2 brushes include all of the features of standard nanoShear brushes (e.g. superior dimensional uniformity, torque stability, and uniform flow distribution), but also include a proprietary PVA treatment process that enables selective fluid flow through the brush nodule.

Treating the nodule and systematically controlling its morphology hydrodynamically prevents adhesion and agglomeration of unwanted process debris which reduces brush loading, wafer scratching excursions, and increases brush lifetime.



Process byproducts/debris

Untreated brush



Nodule treated nanoShear R2 brush



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Applications

Rippey nanoShear R2 brushes are compatible with all major CMP OEMs. Mandrels and tool interfaces are designed for quick and simple exchange.

To prevent bacterial growth and ensure long shelf-life, brushes come preserved in H_2O_2 or NH_4OH , or can be e-beam sterilized.

Depending on the application and cleaning requirements, nanoShear R2 brushes can be customized with various nodule formats.

OEM	Applied Materials	Ebara	
System	Reflexion [®] LK, LK Prime [™]	FREX 300S(2)	FREX 300X(3SC)
PN	*2F*N-70-31NM-0317	*2F*N-38-18NM-0310	*2F*Y-60-32NM-0310
NOTE: nanoShear brushes are only	<i>ı</i> available in 300mm	Preservation * 2 F * N PVAc Formu	(H) 1.00%wt. H_2O_2 (M) 0.25%wt. NH_4OH (E) e-beam lation (S) Symmetry (2) F2 (E) Eclipse (C) Eclipse HCS

Metric

Quality

Every nanoShear R2 brush is measured and characterized to assure 100% conformance of all products shipped.

Every nanoShear R2 brush is individually processed on Rippey's proprietary flow-through cleaning systems. The cleanliness of each brush is quantified by effluent Liquid Particle Counts (LPCs).

The quality of nanoShear R2 brushes are additionally characterized by nodule morphology measurements. Maintaining a consistent nodule texture from brush-to-brush and lot-to-lot is critical to the performance of the product.



Specification

Method

unit

NOTE: Brush physical properties and ionic contamination are PVAc formulation dependent. Contact Rippey Sales or Applications for specific product inquiries.





nanoShear R2 nodule morphology



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